

**2-input Single Supply Translating AND Gate**

**CJ74LV1T08**    Logic

**1 Introduction**

The CJ74LV1T08 is a single, level translating 2-input AND gate. The low threshold inputs support 1.8V input logic at  $V_{CC}=3.3V$  and can be used in 1.8V to 3.3V level up translation. In addition, the 5V tolerant input pins enable level down translation (3.3V to 2.5V output at  $V_{CC}=2.5V$ ). The output level is referenced to the supply voltage and supports 1.8V, 2.5V, 3.3V and 5.0V CMOS levels. The wide  $V_{CC}$  range permits the generation of output levels to connect to controllers or processors.

**2 Available Packages**

PART NUMBER	PACKAGE
CJ74LV1T08	SOT-23-5L
	SOT-353
	DFNWB0.8x0.8-4L

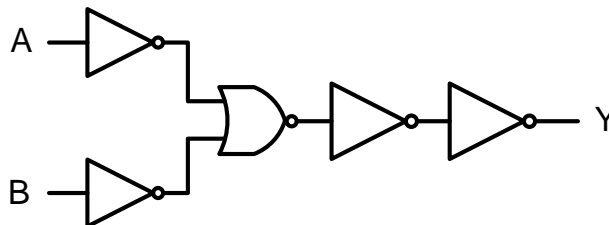
**Note:** For all available packages, please refer to the part Orderable Information.

**3 Features**

- Single supply voltage translator at 1.8V, 2.5V, 3.3V and 5.0V
- Up translation
  - 1.2V to 1.8V at  $V_{CC}=1.8V$
  - 1.5V to 2.5V at  $V_{CC}=2.5V$
  - 1.8V to 3.3V at  $V_{CC}=3.3V$
  - 3.3V to 5.0V at  $V_{CC}=5.0V$
- Down translation
  - 3.3V to 1.8V at  $V_{CC}=1.8V$
  - 3.3V to 2.5V at  $V_{CC}=2.5V$
  - 5.0V to 3.3V at  $V_{CC}=3.3V$
- 5V tolerant inputs
- Specified from -40°C to +125°C

**4 Applications**

- Telecom
- Portable applications
- Servers
- PC and notebooks



Logic diagram

**5 Orderable Information**

DEVICE	PACKAGE	OP TEMP	ECO PLAN	MSL	PACKING OPTION	SORT
CJ74LV1T08M5N	SOT-23-5L	-40~125°C	RoHS & Green	Level 3 168HR	Tape and Reel 3000 Units / Reel	Active
CJ74LV1T08R5N	SOT-353	-40~125°C	RoHS & Green	Level 3 168HR	Tape and Reel 3000 Units / Reel	Active
CJ74LV1T08DJN	DFNWB0.8x0.8-4L	-40~125°C	RoHS & Green	Level 3 168HR	Tape and Reel 12000 Units / Reel	Active

**Note:**

**ECO PLAN:** For the RoHS and Green certification standards of this product, please refer to the official report provided by JSCJ.

**MSL:** Moisture Sensitivity Level. Determined according to JEDEC industry standard classification.

**SORT:** Specifically defined as follows:

Active: Recommended for new products;

Customized: Products manufactured to meet the specific needs of customers;

Preview: The device has been released and has not been fully mass produced. The sample may or may not be available;

NoRD: It is not recommended to use the device for new design. The device is only produced for the needs of existing customers;

Obsolete: The device has been discontinued.

## 6 Pin Configuration and Marking Information

### 6.1 Pin Configuration

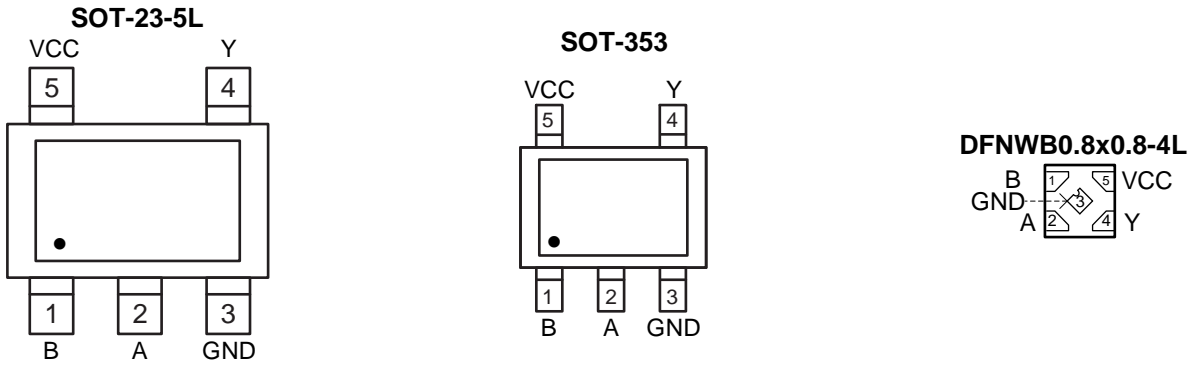


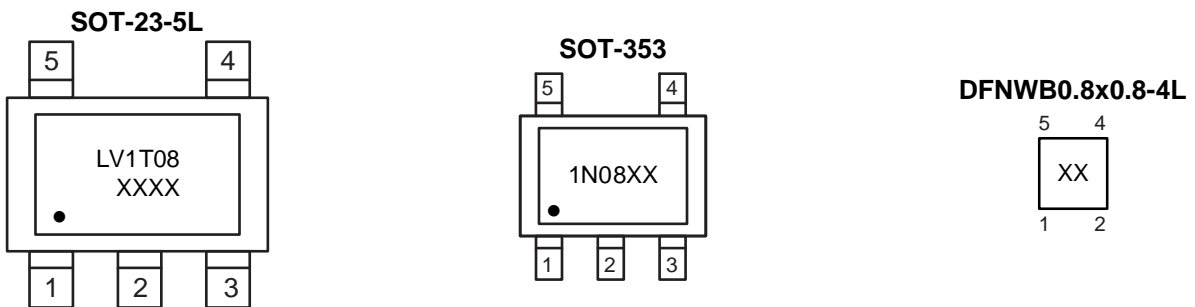
Figure 6-1 Pin configuration

### 6.2 Pin Function

PIN		I/O <sup>(1)</sup>	DESCRIPTION
No.	NAME		
1	B	I	Data input
2	A	I	Data input
3	GND	G	Ground (0V)
4	Y	O	Data output
5	VCC	P	Supply voltage

(1) I-Input, O-Output, P-Power, G-Ground

### 6.3 Marking Information



XXXX or XX: Code, indicates weekly record information.

## 7 Specifications

### 7.1 Absolute Maximum Ratings

$T_{amb}=25^{\circ}\text{C}$ , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CC}$	Supply voltage	-	-0.5	+7.0	V
$V_I$	Input voltage	-(1)	-0.5	+7.0	V
$V_O$	Output voltage	Output HIGH or LOW state <sup>(2)(3)</sup>	-0.5	$V_{CC}+0.5$	V
		Output in power-off state <sup>(2)</sup>	-0.5	+4.6	V
$I_{IK}$	Input clamping current	$V_I < 0\text{V}$	-20	-	mA
$I_{OK}$	Output clamping current	$V_O < 0\text{V}$ or $V_O > V_{CC}$	-	$\pm 20$	mA
$I_O$	Output current	$V_O = 0\text{V}$ to $V_{CC}$	-	$\pm 25$	mA
$I_{CC}$	Supply current	-	-	100	mA
$I_{GND}$	Ground current	-	-50	-	mA
$T_{stg}$	Storage temperature	-	-65	+150	$^{\circ}\text{C}$
$P_{tot}$	Total power dissipation	$T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	-	250	mW
$T_L$	Soldering temperature	10s	-	260	$^{\circ}\text{C}$

(1) If the input current ratings are observed, the minimum input voltage ratings may be exceeded.

(2) If the output current ratings are observed, the output voltage ratings may be exceeded.

(3) This value is limited to 7V maximum.

### 7.2 Recommended Operating Conditions

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{CC}$	Supply voltage	-	1.6	5.0	5.5	V
$V_I$	Input voltage	-	0	-	5.5	V
$V_O$	Output voltage	Output HIGH or LOW state	0	-	$V_{CC}$	V
$T_{amb}$	Ambient temperature	-	-40	-	+125	$^{\circ}\text{C}$
$\Delta t/\Delta V$	Input transition rise and fall rate	$V_{CC} = 1.8\text{V}$ to $5.0\text{V}$	-	-	20	ns/V

**7.3 Electrical Characteristics**
**7.3.1 DC Characteristics 1**
 $T_{amb}=25^{\circ}\text{C}$ , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
$V_{IH}$	HIGH-level input voltage	$V_{CC}=1.65\text{V to }1.8\text{V}$	0.94	-	-	V	
		$V_{CC}=2.0\text{V}$	0.99	-	-	V	
		$V_{CC}=2.25\text{V to }2.5\text{V}$	1.25	-	-	V	
		$V_{CC}=2.75\text{V}$	1.33	-	-	V	
		$V_{CC}=3.0\text{V to }3.3\text{V}$	1.49	-	-	V	
		$V_{CC}=3.6\text{V}$	1.62	-	-	V	
		$V_{CC}=4.5\text{V to }5.0\text{V}$	2.40	-	-	V	
		$V_{CC}=5.5\text{V}$	3.00	-	-	V	
$V_{IL}$	LOW-level input voltage	$V_{CC}=1.65\text{V to }2.0\text{V}$	-	-	0.58	V	
		$V_{CC}=2.25\text{V to }2.75\text{V}$	-	-	0.75	V	
		$V_{CC}=3.0\text{V to }3.6\text{V}$	-	-	0.80	V	
		$V_{CC}=4.5\text{V to }5.5\text{V}$	-	-	0.80	V	
$V_{OH}$	HIGH-level output voltage	$V_I=V_{IH}$ or $V_{IL}$	$V_{CC}=1.65\text{V to }5.5\text{V}; I_o=-20\mu\text{A}$	$V_{CC}-0.1$	-	-	V
			$V_{CC}=1.65\text{V}; I_o=-2\text{mA}$	1.25	-	-	V
			$V_{CC}=1.8\text{V}; I_o=-2\text{mA}$	1.5	-	-	V
			$V_{CC}=2.3\text{V}; I_o=-2.3\text{mA}$	2.0	-	-	V
			$V_{CC}=2.3\text{V}; I_o=-3\text{mA}$	2.0	-	-	V
			$V_{CC}=2.5\text{V}; I_o=-3\text{mA}$	2.25	-	-	V
			$V_{CC}=3.0\text{V}; I_o=-3\text{mA}$	2.78	-	-	V
			$V_{CC}=3.0\text{V}; I_o=-5.5\text{mA}$	2.6	-	-	V
			$V_{CC}=3.3\text{V}; I_o=-5.5\text{mA}$	2.9	-	-	V
			$V_{CC}=4.5\text{V}; I_o=-4\text{mA}$	4.2	-	-	V
			$V_{CC}=4.5\text{V}; I_o=-8\text{mA}$	4.1	-	-	V
$V_{CC}=5.0\text{V}; I_o=-8\text{mA}$	4.6	-	-	V			
$V_{OL}$	LOW-level output voltage	$V_I=V_{IH}$ or $V_{IL}$	$V_{CC}=1.65\text{V to }5.5\text{V}; I_o=20\mu\text{A}$	-	-	0.1	V
			$V_{CC}=1.65\text{V}; I_o=2\text{mA}$	-	-	0.2	V
			$V_{CC}=2.3\text{V}; I_o=2.3\text{mA}$	-	-	0.1	V
			$V_{CC}=2.3\text{V}; I_o=3\text{mA}$	-	-	0.15	V
			$V_{CC}=3.0\text{V}; I_o=3\text{mA}$	-	-	0.1	V
			$V_{CC}=3.0\text{V}; I_o=5.5\text{mA}$	-	-	0.2	V
			$V_{CC}=4.5\text{V}; I_o=4\text{mA}$	-	-	0.15	V
			$V_{CC}=4.5\text{V}; I_o=8\text{mA}$	-	-	0.3	V
$I_I$	Input leakage current	$V_I=V_{CC}$ or GND; $V_{CC}=0\text{V to }5.5\text{V}$	-	-	$\pm 0.1$	$\mu\text{A}$	

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CC</sub>	Supply current	V <sub>I</sub> =V <sub>CC</sub> or GND; I <sub>O</sub> =0A; V <sub>CC</sub> =1.8V, 2.5V, 3.3V, 5.0V	-	-	1	uA
ΔI <sub>CC</sub>	Additional supply current	Per input pin; V <sub>CC</sub> =1.8V; V <sub>I</sub> =0.3V or 1.1V; I <sub>O</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	10	uA
		Per input pin; V <sub>CC</sub> =5.5V; V <sub>I</sub> =0.3V or 3.4V; I <sub>O</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	1.35	mA

### 7.3.2 DC Characteristics 2

T<sub>amb</sub>=-40°C to +85°C, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> =1.65V to 1.8V	1.00	-	-	V	
		V <sub>CC</sub> =2.0V	1.04	-	-	V	
		V <sub>CC</sub> =2.25V to 2.5V	1.30	-	-	V	
		V <sub>CC</sub> =2.75V	1.38	-	-	V	
		V <sub>CC</sub> =3.0V to 3.3V	1.54	-	-	V	
		V <sub>CC</sub> =3.6V	1.67	-	-	V	
		V <sub>CC</sub> =4.5V to 5.0V	2.45	-	-	V	
		V <sub>CC</sub> =5.5V	3.05	-	-	V	
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> =1.65V to 2.0V	-	-	0.55	V	
		V <sub>CC</sub> =2.25V to 2.75V	-	-	0.71	V	
		V <sub>CC</sub> =3.0V to 3.6V	-	-	0.65	V	
		V <sub>CC</sub> =4.5V to 5.5V	-	-	0.80	V	
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>	V <sub>CC</sub> =1.65V to 5.5V; I <sub>O</sub> =-20uA	V <sub>CC</sub> -0.1	-	-	V
			V <sub>CC</sub> =1.65V; I <sub>O</sub> =-2mA	1.21	-	-	V
			V <sub>CC</sub> =1.8V; I <sub>O</sub> =-2mA	1.45	-	-	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =-2.3mA	2.0	-	-	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =-3mA	1.93	-	-	V
			V <sub>CC</sub> =2.5V; I <sub>O</sub> =-3mA	2.15	-	-	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =-3mA	2.7	-	-	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =-5.5mA	2.49	-	-	V
			V <sub>CC</sub> =3.3V; I <sub>O</sub> =-5.5mA	2.8	-	-	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =-4mA	4.1	-	-	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =-8mA	3.95	-	-	V
V <sub>CC</sub> =5.0V; I <sub>O</sub> =-8mA	4.5	-	-	V			

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>	V <sub>CC</sub> =1.65V to 5.5V; I <sub>o</sub> =20uA	-	-	0.1	V
			V <sub>CC</sub> =1.65V; I <sub>o</sub> =2mA	-	-	0.25	V
			V <sub>CC</sub> =2.3V; I <sub>o</sub> =2.3mA	-	-	0.15	V
			V <sub>CC</sub> =2.3V; I <sub>o</sub> =3mA	-	-	0.2	V
			V <sub>CC</sub> =3.0V; I <sub>o</sub> =3mA	-	-	0.15	V
			V <sub>CC</sub> =3.0V; I <sub>o</sub> =5.5mA	-	-	0.252	V
			V <sub>CC</sub> =4.5V; I <sub>o</sub> =4mA	-	-	0.2	V
			V <sub>CC</sub> =4.5V; I <sub>o</sub> =8mA	-	-	0.35	V
I <sub>I</sub>	Input leakage current	V <sub>I</sub> =V <sub>CC</sub> or GND; V <sub>CC</sub> =0V to 5.5V	-	-	±1	uA	
I <sub>CC</sub>	Supply current	V <sub>I</sub> =V <sub>CC</sub> or GND; I <sub>o</sub> =0A; V <sub>CC</sub> =1.8V, 2.5V, 3.3V, 5.0V	-	-	10	uA	
ΔI <sub>CC</sub>	Additional supply current	Per input pin; V <sub>CC</sub> =1.8V; V <sub>I</sub> =0.3V or 1.1V; I <sub>o</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	10	uA	
		Per input pin; V <sub>CC</sub> =5.5V; V <sub>I</sub> =0.3V or 3.4V; I <sub>o</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	1.5	mA	

### 7.3.3 DC Characteristics 3

T<sub>amb</sub>=-40°C to +125°C, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> =1.65V to 1.8V	1.0	-	-	V
		V <sub>CC</sub> =2.0V	1.04	-	-	V
		V <sub>CC</sub> =2.25V to 2.5V	1.30	-	-	V
		V <sub>CC</sub> =2.75V	1.38	-	-	V
		V <sub>CC</sub> =3.0V to 3.3V	1.54	-	-	V
		V <sub>CC</sub> =3.6V	1.67	-	-	V
		V <sub>CC</sub> =4.5V to 5.0V	2.45	-	-	V
		V <sub>CC</sub> =5.5V	3.05	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> =1.65V to 2.0V	-	-	0.55	V
		V <sub>CC</sub> =2.25V to 2.75V	-	-	0.71	V
		V <sub>CC</sub> =3.0V to 3.6V	-	-	0.65	V
		V <sub>CC</sub> =4.5V to 5.5V	-	-	0.80	V

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>	V <sub>CC</sub> =1.65V to 5.5V; I <sub>O</sub> =-20uA	V <sub>CC</sub> -0.1	-	-	V
			V <sub>CC</sub> =1.65V; I <sub>O</sub> =-2mA	1.21	-	-	V
			V <sub>CC</sub> =1.8V; I <sub>O</sub> =-2mA	1.45	-	-	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =-2.3mA	2.0	-	-	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =-3mA	1.93	-	-	V
			V <sub>CC</sub> =2.5V; I <sub>O</sub> =-3mA	2.15	-	-	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =-3mA	2.7	-	-	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =-5.5mA	2.49	-	-	V
			V <sub>CC</sub> =3.3V; I <sub>O</sub> =-5.5mA	2.8	-	-	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =-4mA	4.1	-	-	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =-8mA	3.95	-	-	V
			V <sub>CC</sub> =5.0V; I <sub>O</sub> =-8mA	4.5	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>	V <sub>CC</sub> =1.65V to 5.5V; I <sub>O</sub> =20uA	-	-	0.1	V
			V <sub>CC</sub> =1.65V; I <sub>O</sub> =2mA	-	-	0.25	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =2.3mA	-	-	0.15	V
			V <sub>CC</sub> =2.3V; I <sub>O</sub> =3mA	-	-	0.2	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =3mA	-	-	0.15	V
			V <sub>CC</sub> =3.0V; I <sub>O</sub> =5.5mA	-	-	0.252	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =4mA	-	-	0.2	V
			V <sub>CC</sub> =4.5V; I <sub>O</sub> =8mA	-	-	0.35	V
I <sub>I</sub>	Input leakage current	V <sub>I</sub> =V <sub>CC</sub> or GND; V <sub>CC</sub> =0V to 5.5V	-	-	±1	uA	
I <sub>CC</sub>	Supply current	V <sub>I</sub> =V <sub>CC</sub> or GND; I <sub>O</sub> =0A; V <sub>CC</sub> =1.8V, 2.5V, 3.3V, 5.0V	-	-	10	uA	
ΔI <sub>CC</sub>	Additional supply current	Per input pin; V <sub>CC</sub> =1.8V; V <sub>I</sub> =0.3V or 1.1V; I <sub>O</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	10	uA	
		Per input pin; V <sub>CC</sub> =5.5V; V <sub>I</sub> =0.3V or 3.4V; I <sub>O</sub> =0A; Other pins at V <sub>CC</sub> or GND	-	-	1.5	mA	

7.3.4 AC Characteristics

T<sub>amb</sub>=-40°C to +125°C, GND=0V, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	-40°C to +125°C					UNIT	
			MIN.	TYP. 25°C	MAX. 25°C	MAX. 85°C	MAX. 125°C		
t <sub>pd</sub>	Propagation delay	A, B to Y; See Figure 8-5 <sup>(1)</sup>	V <sub>CC</sub> =1.8V; C <sub>L</sub> =15pF	-	13	19.4	21.8	23.4	ns
			V <sub>CC</sub> =1.8V; C <sub>L</sub> =30pF	-	15.2	21.8	24.8	26.8	ns
			V <sub>CC</sub> =2.5V; C <sub>L</sub> =15pF	-	9.2	13.2	15.2	16.4	ns
			V <sub>CC</sub> =2.5V; C <sub>L</sub> =30pF	-	10.6	15	17.2	18.4	ns
			V <sub>CC</sub> =3.3V; C <sub>L</sub> =15pF	-	7.6	10.8	12.2	13	ns
			V <sub>CC</sub> =3.3V; C <sub>L</sub> =30pF	-	8.8	12.2	13.6	14.6	ns
			V <sub>CC</sub> =5.0V; C <sub>L</sub> =15pF	-	6.4	8.2	9	9.4	ns
			V <sub>CC</sub> =5.0V; C <sub>L</sub> =30pF	-	7.2	9.2	10.2	10.8	ns
C <sub>i</sub>	Input capacitance	V <sub>i</sub> =V <sub>CC</sub> or GND; V <sub>CC</sub> =3.3V	-	1.5	10	10	10	pF	
C <sub>o</sub>	Output capacitance	V <sub>o</sub> =V <sub>CC</sub> or GND; V <sub>CC</sub> =3.3V	-	2.5	-	-	-	pF	
C <sub>PD</sub>	Power dissipation capacitance	Per buffer; V <sub>i</sub> =GND to V <sub>CC</sub> ; C <sub>L</sub> =30pF; f=10MHz <sup>(2)</sup>	V <sub>CC</sub> =1.8V	-	4.2	-	-	-	pF
			V <sub>CC</sub> =2.5V	-	5.3	-	-	-	pF
			V <sub>CC</sub> =3.3V	-	7.2	-	-	-	pF
			V <sub>CC</sub> =5.0V	-	11.1	-	-	-	pF

(1) t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

(2) C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in uW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub>=input frequency in MHz;

f<sub>o</sub>=output frequency in MHz;

C<sub>L</sub>=output load capacitance in pF;

V<sub>CC</sub>=supply voltage in V;

N=number of inputs switching;

∑(C<sub>L</sub>×V<sub>CC</sub><sup>2</sup>×f<sub>o</sub>)=sum of the outputs.

## 8 Detailed Description

### 8.1 Overview

The CJ74LV1T08 is a single, level translating 2-input AND gate. The low threshold inputs support 1.8V input logic at  $V_{CC}=3.3V$  and can be used in 1.8V to 3.3V level up translation. In addition, the 5V tolerant input pins enable level down translation (3.3V to 2.5V output at  $V_{CC}=2.5V$ ). The output level is referenced to the supply voltage and supports 1.8V, 2.5V, 3.3V and 5.0V CMOS levels. The wide  $V_{CC}$  range permits the generation of output levels to connect to controllers or processors.

### 8.2 Functional Block Diagram

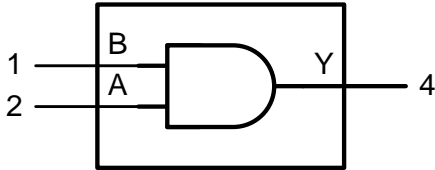


Figure 8-1 Logic symbol



Figure 8-2 logic symbol

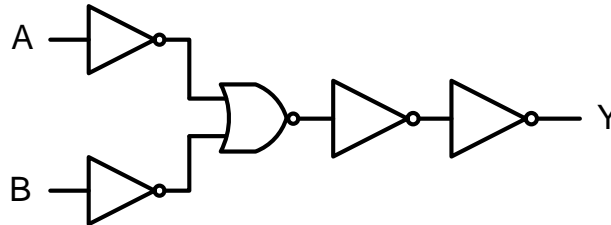


Figure 8-3 Logic diagram

### 8.3 Function Table

INPUT		OUTPUT
A	B	Y
L	L	L
L	H	L
H	L	L
H	H	H

**Note:** H=HIGH voltage level; L=LOW voltage level.

8.4 Testing Circuit

8.4.1 AC Testing Circuit

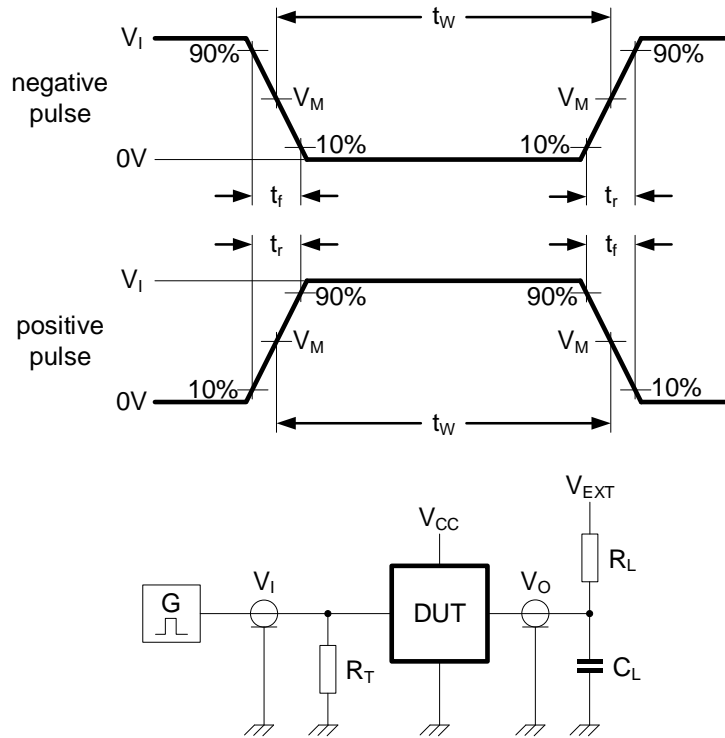


Figure 8-4 Test circuit for measuring switching times

Definitions test circuit:

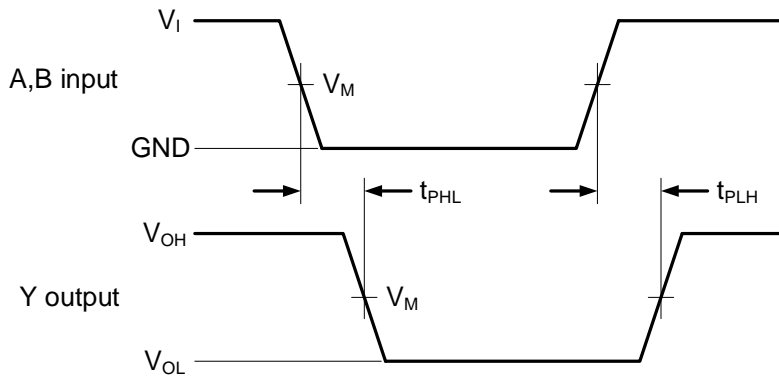
$R_T$ =Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator

$C_L$ =Load capacitance including jig and probe capacitance

$R_L$ =Load resistance

$V_{EXT}$ =External voltage for measuring switching times

8.4.2 AC Testing Waveforms



$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Figure 8-5 The input A,B to output Y propagation delays

8.4.3 Measurement Points

INPUT	OUTPUT
$V_M$	$V_M$
$0.5 \times V_I$	$0.5 \times V_{CC}$

**8.4.4 Test Data**

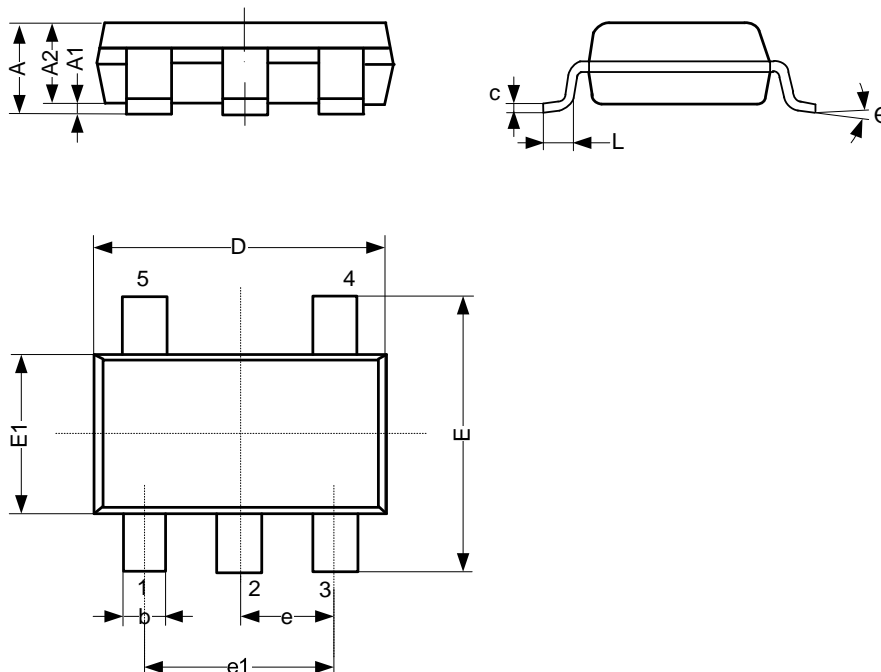
SUPPLY VOLTAGE	INPUT			LOAD		V <sub>EXT</sub>		
V <sub>CC</sub>	V <sub>I</sub>	$\Delta t/\Delta V^{(1)}$	f <sub>max</sub>	C <sub>L</sub>	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
1.8V	V <sub>CC</sub>	≤1.0ns/V	15MHz	15pF,30pF	1MΩ	GND	GND	V <sub>CC</sub>
2.5V	V <sub>CC</sub>	≤1.0ns/V	25MHz	15pF,30pF	1MΩ	GND	GND	V <sub>CC</sub>
3.3V	3V	≤1.0ns/V	50MHz	15pF,30pF	1MΩ	GND	GND	V <sub>CC</sub>
5.0V	3V	≤1.0ns/V	50MHz	15pF,30pF	1MΩ	GND	GND	V <sub>CC</sub>

(1)  $dV/dt \geq 1.0V/ns$ .

9 Mechanical Information

9.1 SOT-23-5L Mechanical Information

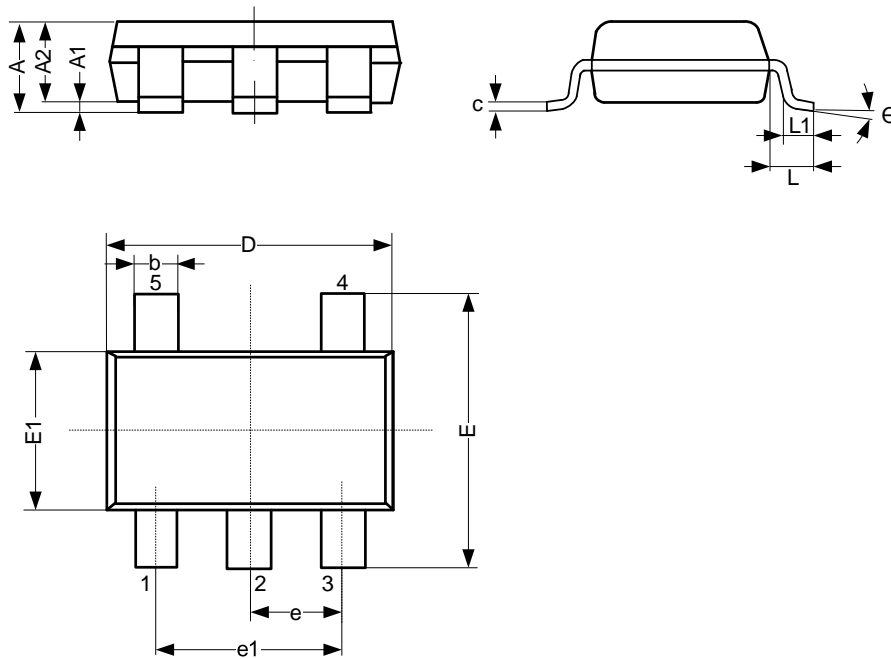
9.1.1 SOT-23-5L Outline Dimensions



SYMBOL	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	-	-	1.26
A1	0.00	-	0.12
A2	1.00	-	1.20
b	0.30	-	0.50
c	0.10	-	0.20
D	2.82	-	3.02
E	2.60	-	3.00
E1	1.50	-	1.70
e	0.95 BSC		
e1	1.80	-	2.00
L	0.30	-	0.60
Θ	0°	-	8°
Unit: mm			

9.2 SOT-353 Mechanical Information

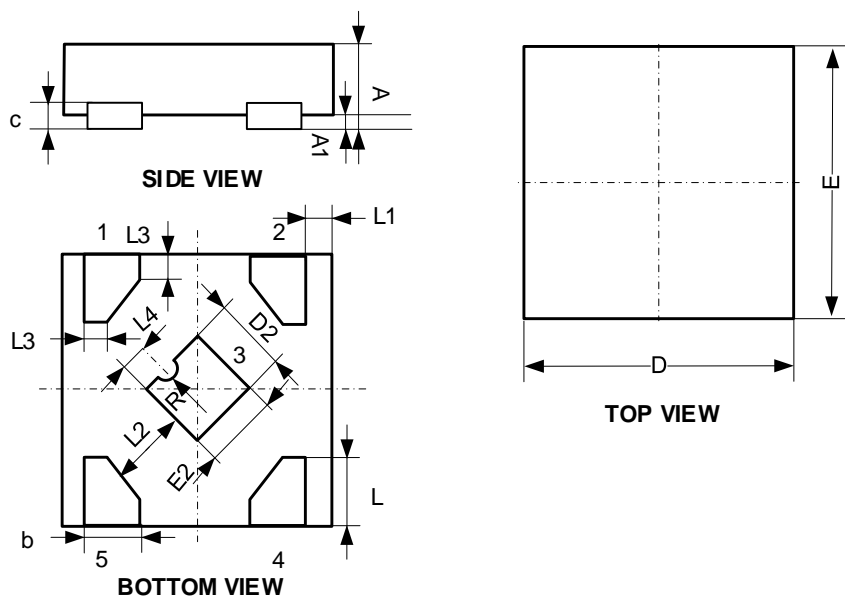
9.2.1 SOT-353 Outline Dimensions



SYMBOL	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.90	-	1.10
A1	0.00	-	0.10
A2	0.90	-	1.00
b	0.15	-	0.35
c	0.11	-	0.175
D	2.00	-	2.20
E	2.15	-	2.45
E1	1.15	-	1.35
e	0.65 BSC		
e1	1.20	-	1.40
L	-	0.525	-
L1	0.26	-	0.46
Θ	0°	-	8°
Unit: mm			

9.3 DFNWB0.8x0.8-4L Mechanical Information

9.3.1 DFNWB0.8x0.8-4L Outline Dimensions



SYMBOL	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.37	-	0.43
A1	0.00	-	0.05
b	0.15	-	0.25
c	-	0.127	-
D	0.75	-	0.85
D2	0.20	-	0.40
E	0.75	-	0.85
E2	0.20	-	0.40
e	0.50 BSC		
L	0.15	-	0.25
L1	-	0.05	-
L2	-	0.20	-
L3	-	0.055	-
L4	-	0.10	-
R	-	0.05	-
Unit: mm			

## 10 Notes and Revision History

### 10.1 Associated Product Family and Others

To view other products of the same type or IC products of other types, click the official website of JSCJ -- <https://www.jscj-elec.com> for more details.

### 10.2 Notes

#### Electrostatic Discharge Caution



This IC may be damaged by ESD. Relevant personnel shall comply with correct installation and use specifications to avoid ESD damage to the IC. If appropriate measures are not taken to prevent ESD damage, the hazards caused by ESD include but are not limited to degradation of integrated circuit performance or complete damage of integrated circuit. For some precision integrated circuits, a very small parameter change may cause the whole device to be inconsistent with its published specifications.

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